



Click [here](#) for the 3D model.

General Information

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|--------------------------|----------------------------|
| Series | T495 |
| Dielectric | MnO2 Tantalum |
| Style | SMD Chip |
| Description | SMD, MnO2, Molded, Low ESR |
| Features | Low ESR |
| RoHS | Yes |
| Termination | Tin |
| Typical Component Weight | 224.48 mg |
| Shelf Life | 156 Weeks |
| MSL | 1 |

Dimensions

| | |
|---|--------------------|
| L | 6mm +/-0.3mm |
| W | 3.2mm +/-0.3mm |
| H | 2.5mm +/-0.3mm |
| T | 0.13mm REF |
| S | 1.3mm +/-0.3mm |
| F | 2.2mm +/-0.1mm |
| A | 2.9mm MIN |
| B | 0.5mm +/-0.15mm |
| E | 2.4mm REF |
| G | 2.8mm REF |
| P | 0.9mm REF |
| R | 1mm REF |
| X | 0.1mm +/-0.1mm REF |

Specifications

| | |
|--------------------|---|
| Capacitance | 47 uF |
| Tolerance | 20% |
| Voltage DC | 6.3 VDC (85C), 4.22 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 85°C |
| Dissipation Factor | 6% 120Hz 25C |
| Failure Rate | N/A |
| ESR | 300 mOhms (100kHz 25C) |
| Ripple Current | 606 mA (rms, 100kHz 25C), 545.4 mA (rms, 85C), 242.4 mA (rms, 125C) |
| Leakage Current | 3 uA (5min 25°C) |

Packaging Specifications

| | |
|--------------------|------------|
| Packaging | T&R, 178mm |
| Packaging Quantity | 500 |

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